

Datasheet revision 1.0

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ROM1 RMA Tack Flux (for Lead-Free) in 10cc/10g Luer Lock Manual Syringe w/tips

Product Highlights Tack Flux Rosin Mildly Activated (RMA) Used for touch up and rework, attachment of BGA spheres, and soldering flip chip components. Low viscosity synthetic RoHS 3 and REACH compliant

Specifications

Flux Type: Flux Classification:

Flux Activation Temperature: Packaging: Shelf Life: Synthetic RMA (for Lead-Free applications) ROM1 (Must be cleaned off post-use using Flux Remover or IPA) 140°C (284°F) 10cc/10g Luer Lock Manual Syringe Refrigerated >24 months, Unrefrigerated >24 months



Stencil Life

>8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Conforms to the following Industry Standards: J-STD-004B, Amendment 1 (Solder Fluxes): RoHS 3 Directive (EU) 2015/863:

Yes Yes